**PRODUCT/PROCESS CHANGE NOTICE (PCN)**

<table>
<thead>
<tr>
<th>PCN #: TB1507-01</th>
<th>DATE: August 18, 2015</th>
<th>MEANS OF DISTINGUISHING CHANGED DEVICES:</th>
</tr>
</thead>
<tbody>
<tr>
<td>Product Affected: Selective part# of VFQFPN-16</td>
<td></td>
<td>Lot shipments will have Level 1 Moisture Sensitive Label</td>
</tr>
<tr>
<td>(Refer to Attachment II for affected part#)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Date Effective: August 18, 2015</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Contact: IDT PCN DESK</td>
<td></td>
<td></td>
</tr>
<tr>
<td>E-mail: <a href="mailto:pcndesk@idt.com">pcndesk@idt.com</a></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Attachment: Yes</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Samples: N/A</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**DESCRIPTION AND PURPOSE OF CHANGE:**

This notification is to advise our customers that IDT is converting moisture sensitivity classification to MSL 1. The affected products will be shipped without dry pack and labeled as MSL 1 according to JEDEC J-STD-020. There is no change to the assembly material sets and the peak reflow temperature.

Attachment I details the qualification data and the examples of moisture sensitive labels. Attachment II shows the list of the affected part numbers.

**RELIABILITY/QUALIFICATION SUMMARY:**

Moisture sensitive classification qual report is in attachment I.

**CUSTOMER ACKNOWLEDGMENT OF RECEIPT:**

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: ____________________________

Name/Date: __________________________ E-Mail Address: __________________________

Title: ____________________________ Phone# /Fax#: __________________________

**CUSTOMER COMMENTS:**

______________________________

**IDT ACKNOWLEDGMENT OF RECEIPT:**

RECD. BY: _____________________________ DATE: ____________________________
ATTACHMENT I - PCN #: TB1507-01

PCN Type: Change in Moisture Sensitivity Level

Data Sheet Change: There is change in Moisture Sensitive Level (MSL) from 3 to 1.

Detail of Change: This notification is to advise our customers that IDT is converting moisture sensitivity classification to MSL 1.

The affected products will be shipped without dry pack and labeled as MSL 1 according to JEDEC J-STD-020. There is no change to the assembly material sets and the peak reflow temperature. Peak reflow temperature remains 260°C.

Refer to examples of moisture sensitive labels as shown below.

Qualification Information and Qualification Data:

Qual Plan & Results: Tests are in accordance with JEDEC47 recommended tests.

Qualification Vehicle: VFQFPN-16

<table>
<thead>
<tr>
<th>Test Description</th>
<th>Test Method</th>
<th>Lot 1</th>
<th>Lot 2</th>
<th>Lot 3</th>
</tr>
</thead>
<tbody>
<tr>
<td>* HAST - biased (130 °C/85% RH, 100 Hrs)</td>
<td>JESD22-A110</td>
<td>45/0</td>
<td>45/0</td>
<td>45/0</td>
</tr>
<tr>
<td>* Temperature Cycle / Condition B</td>
<td>JESD22-A104</td>
<td>45/0</td>
<td>45/0</td>
<td>45/0</td>
</tr>
<tr>
<td>High Temp. Storage Test (150 °C, 1000 Hrs)</td>
<td>JESD22-A103</td>
<td>77/0</td>
<td>77/0</td>
<td>77/0</td>
</tr>
<tr>
<td>Moisture Sensitivity Level (MSL 1, 260°C)</td>
<td>J-STD-20</td>
<td>45/0</td>
<td>45/0</td>
<td>45/0</td>
</tr>
</tbody>
</table>

* Test requires moisture pre-conditioning sequence per JESD22-A113 prior to stress test

From: MSL 3 Moisture Sensitive Label

To: MSL 1 Non-Moisture Sensitive Label

CAUTION This Bag Contains MOISTURE-SENSITIVE DEVICES

1. Calculated shelf life in sealed bag 12 months at < 40°C and < 90% relative humidity (RH)
2. Package body temperature: 260°C
3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must
   a) Mounted within 156 hours of factory conditions <= 30°C/60% RH
   b) Stored per J-STD-033
4. Devices required bake, before mounting it:
   a) Humidity indicator card reads > 10% for level 2a-5a devices of >50% for level 2 devices when read at 23+/-5 deg C
   b) 36 or 36c are not inert
5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure

Bag Seal Date: 07/31/15
Note: Level and body temperature defined by IPC/JEDEC J-STD-020.

CAUTION Level 3

Not Moisture Sensitive

These Devices do not require special storage conditions provided:

1. They are maintained at conditions equal to or less than 30°C/60% RH, and
2. They are solder reflowed at a peak body temperature which does not exceed 260°C

Note: Level and body temperature defined by IPC/JEDEC J-STD-020.

Note: There is no change to the peak reflow temperature of the affected products.
# PRODUCT/PROCESS CHANGE NOTICE (PCN)

**ATTACHMENT II - PCN #: TB1507-01**

## Affected Part Numbers

<table>
<thead>
<tr>
<th>Part Number</th>
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<th>Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>F2250NLGI</td>
<td>F2258NLGI</td>
<td>F2255NLGI8</td>
<td>F2250NLGK</td>
</tr>
<tr>
<td>F2258NLGK</td>
<td>F2255NLGK8</td>
<td>F2255NLGI</td>
<td>F2250NLGI8</td>
</tr>
<tr>
<td>F2258NLGI8</td>
<td>F2255NLGK</td>
<td>F2250NLGK8</td>
<td>F2258NLGK8</td>
</tr>
</tbody>
</table>